

ATTY DKT. No.:

U.S. SERIAL NO .: FILED:

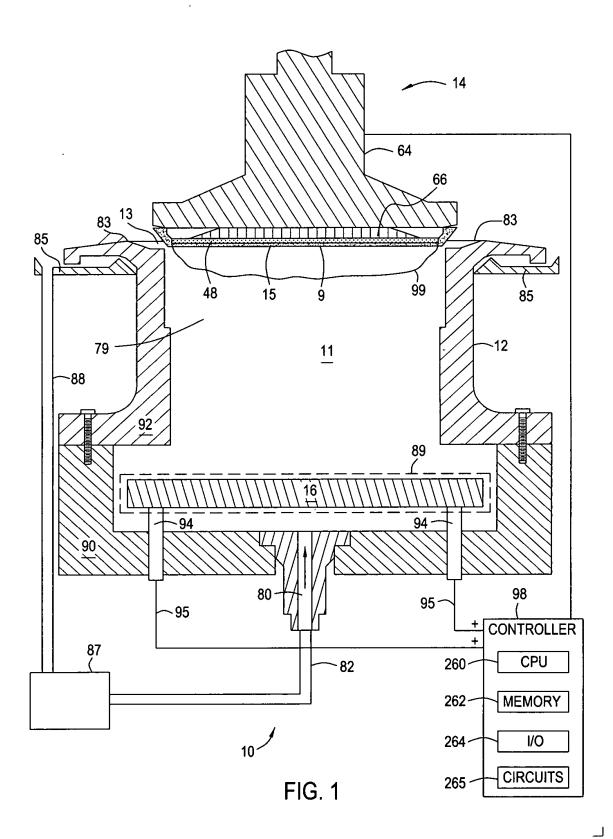
APPLICANT:

AMAT/4471.Y1/CMP/ECP/RKK
09/614,407 CONF. NO.: 1
JULY 12, 2000
APPLIED MATERIALS, INC.
METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE
METAL DEPOSITION
TAKENG ET AL TITLE:

INVENTOR: ZHENG, ET AL.

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CONF. No.: 1903





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09/614,407 CONF. NO.: 1

JULY 12, 2000

APPLIED MATERIALS, INC.

METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE

METAL DEPOSITION

APPLICANT: TITLE:

METAL DEPOSITION

INVENTOR:

ZHENG, ET AL.

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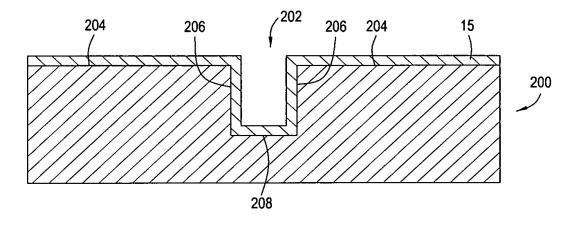


FIG. 2A

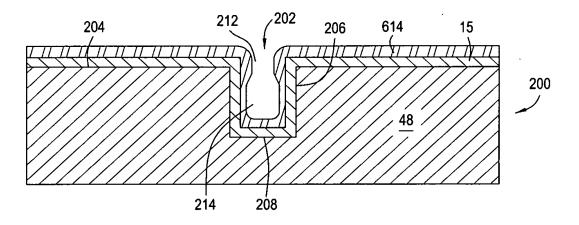


FIG. 2B



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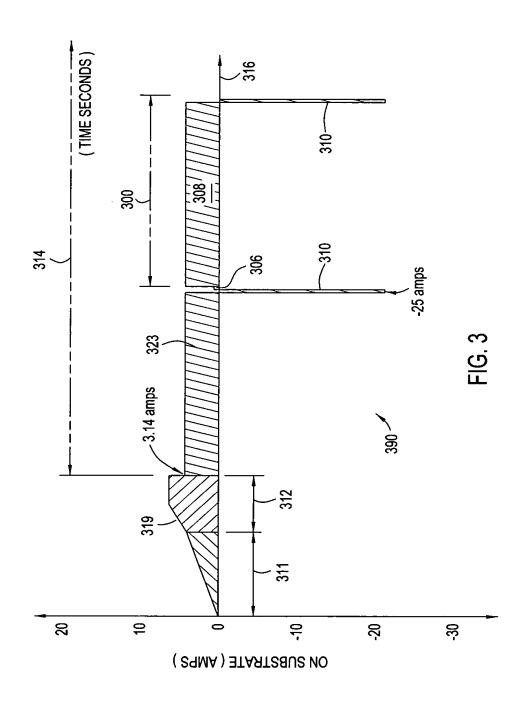
AMAT/4471.Y1/CMP/ECP/RKK
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INVENTOR:

ZHENG, ET AL.

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ATTY DKT. No.: AMAT/4471.Y1/CMP/ECP/RKK U.S. SERIAL No.: 09/614,407

U.S. SERIAL NO.: 09/614,407 FILED: JULY 12, 2000

APPLICANT: APPLIED MATERIALS, INC.

TITLE: METHOD OF APPLICATION

INVENTOR: ZHENG, ET

METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE

METAL DEPOSITION

ZHENG, ET AL.

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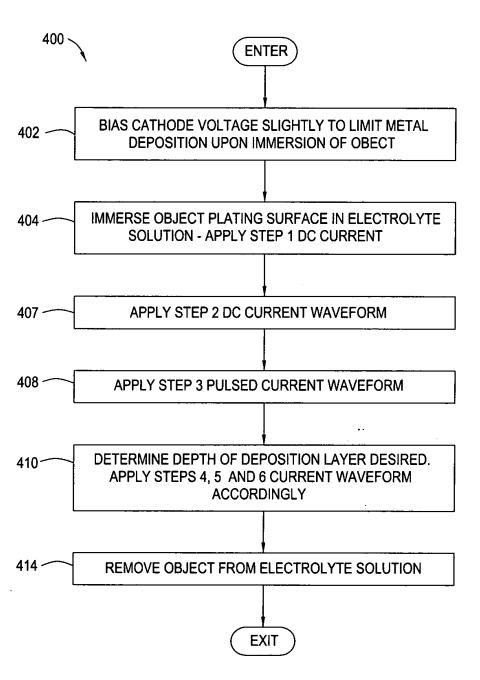


FIG. 4

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AMAT/4471.Y1/CMP/ECP/RKK 09/614,407 JULY 12, 2000 ATTY DKT. No.: U.S. SERIAL No.:

FILED:

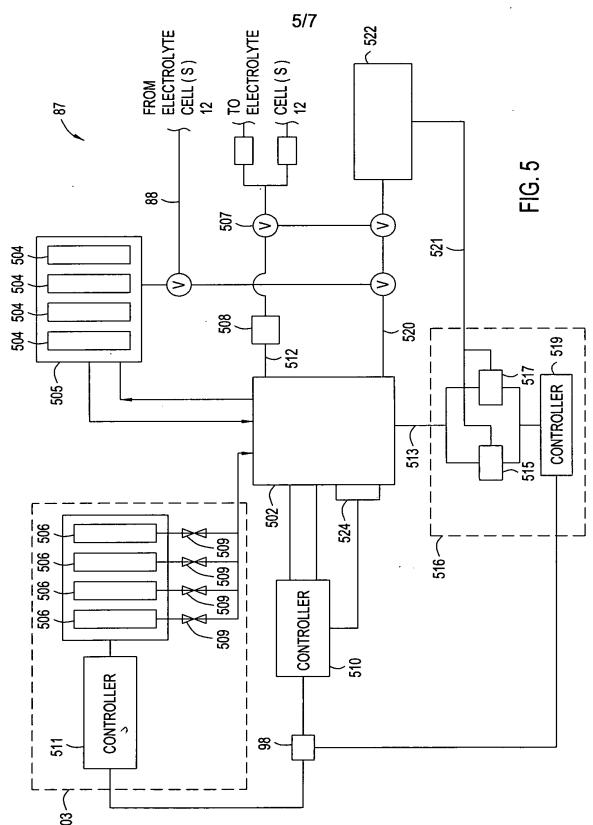
APPLICANT: TITLE: APPLIED MATERIALS, INC. METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE

METAL DEPOSITION ZHENG, ET AL.

INVENTOR:

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APPLIED MATERIALS, INC. METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE

TITLE:

INVENTOR:

ZHENG, ET AL.

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METAL DEPOSITION

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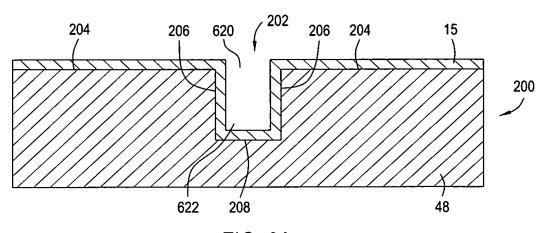


FIG. 6A

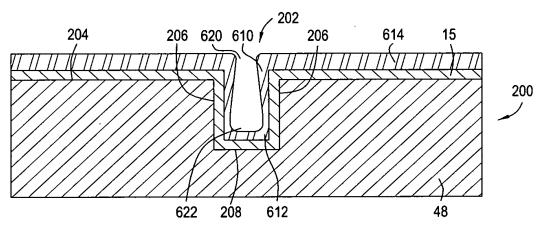


FIG. 6B

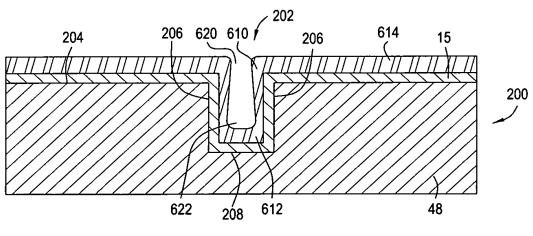


FIG. 6C



AMAT/4471.Y1/CMP/ECP/RKK 09/614,407 ATTY DKT. NO.:

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METHOD OF APPLICATION OF ELECTRICAL BIASING TO ENHANCE TITLE:

METAL DEPOSITION

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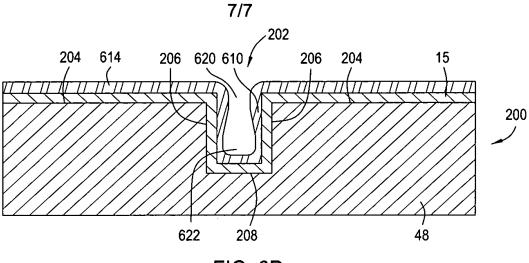


FIG. 6D

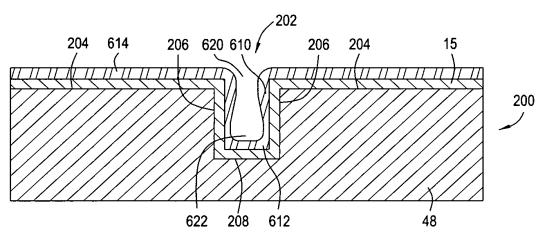


FIG. 6E

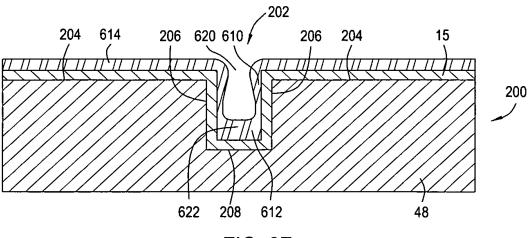


FIG. 6F